

MSF14N60

N-Channel Enhancement Mode Power MOSFET

Description

The MSF14N60 is a N-channel enhancement-mode MOSFET, providing the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness. The ITO-220AB package is universally preferred for all commercial-industrial applications

Features

- Low On Resistance
- Simple Drive Requirement
- Fast Switching Characteristic
- Insulating package, front/back side insulating voltage=2500V(AC)
- RoHS compliant package

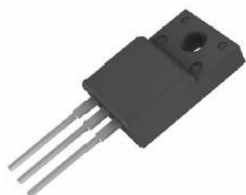
Application

- Adapter
- Switching Mode Power Supply

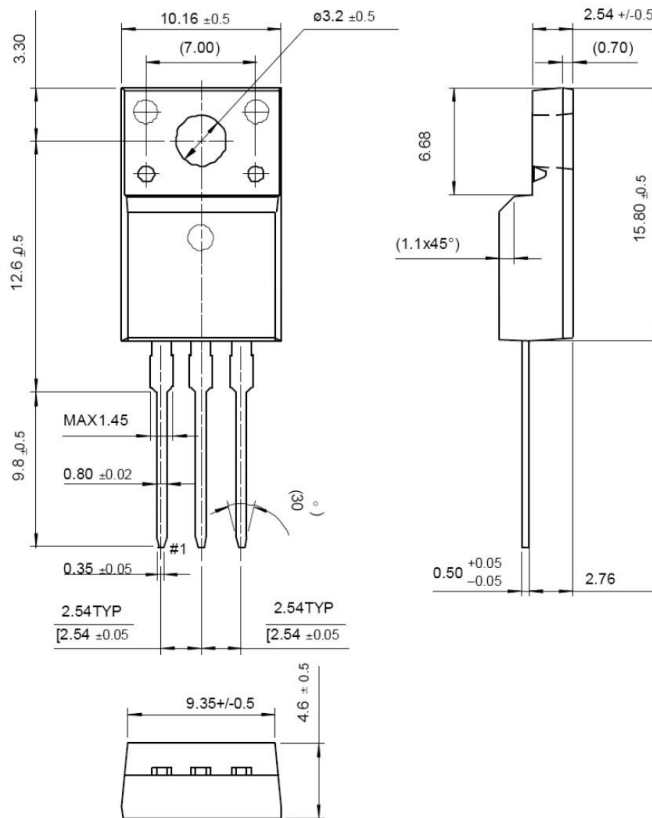
Package type : ITO220-AB

Packing & Order Information

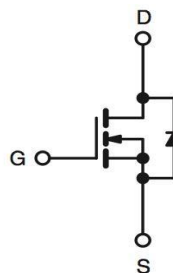
50/Tube ; 1,000/Box



**RoHS
COMPLIANT**



Graphic symbol



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	600	V
V _{GS}	Gate-Source Voltage	±30	V
I _D	Drain Current -Continuous (TC=25°C)	14	A
	Drain Current -Continuous (TC=100°C)	8.4	A
I _{DM}	Drain Current Pulsed	56	A
E _{AS}	Single Pulsed Avalanche Energy	53	mJ
I _{AR}	Avalanche Current	14.0	A
E _{AR}	Repetitive Avalanche Energy	16	mJ
dV/dt	Peak Diode Recovery dV/dt	4.5	V/ns

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Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
P _D	Total Power Dissipation(@TC = 25 °C) 60 W	60	W
	Derating Factor above 25 °C	0.35	W/°C

- Drain current limited by maximum junction temperature

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
T _L	Maximum Temperature for Soldering @ Lead at 0.125 in(0.318mm) from case for 10 seconds	300	°C
T _{STG}	Operating Junction Temperature	-55 ~ 150	W
T _J	Storage Temperature	150	°C

Note:

1. Repetitive rating; pulse width limited by maximum junction temperature.
2. I_{AS}=14A, V_{DD}=50V, L=0.5mH, R_G=25Ω, starting T_J=+25°C.
3. I_{SD}≤7.5A, di/dt≤100A/μs, V_{DD}≤B_VD_{SS}, starting T_J=+25°C.
4. Drain current limited by maximum junction temperature

Thermal characteristics

Symbol	Parameter	Max.	Units
R _{θJC}	Thermal Resistance, Junction-to-Case	2.58	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	100	

Static Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	2.0	--	4.0	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3A	--	--	0.55	Ω
B _V D _{SS}	Drain-Source Breakdown Voltage	V _{GS} =0 V, I _D =250μA T _J =150°C	600	660	--	V
ΔB _V D _{SS} /ΔT _J	Breakdown Voltage Temperature Coefficient	I _D =250μA, Referenced to 25°C	--	0.7	--	V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =600V, V _{GS} = 0 V V _{DS} =480V, T _C = 125°C	--	--	1 10	μA
I _{GSS}	Gate-Body Leakage, Forward	V _{GS} =±30	--	--	±100	nA

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Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Time	$V_{DS}=250\text{ V}, I_D=14\text{ A},$ $V_{GS}=10\text{ V}, R_G=9.1\Omega$	--	40	--	ns
t_r	Turn-On Time		--	10	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	15	--	ns
t_f	Turn-Off Fall Time		--	16	--	ns
Q_g	Total Gate Charge	$V_{DS}=250\text{ V}, I_D=14\text{ A},$ $V_{GS}=10\text{ V}$	--	30	--	nC
Q_{gs}	Gate-Source Charge		--	48	--	nC
Q_{gd}	Gate-Drain Charge (Miller Charge)		--	34	--	nC

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
C_{iss}	Input Capacitance	$V_{DS}=25\text{ V}, V_{GS}=0\text{ V},$ $f=1.0\text{ MHz}$	--	2222	--	pF
C_{oss}	Output Capacitance		--	180	--	pF
C_{rss}	Reverse Transfer Capacitance		--	17	--	pF

Source-Drain Diode Maximum Ratings and Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
I_S		$V_D=V_G=0,$ $V_S=1.3\text{ V}$	--	--	14	A
I_{SM}			--	--	56	
V_{SD}		$I_S=12\text{ A}, V_{GS}=0\text{ V}$	--	--	1.5	V
t_{rr}		$I_S=12\text{ A}, V_{GS}=0\text{ V}$	--	392	--	ns
Q_{rr}		$diF/dt=100\text{ A}/\mu\text{s}$	--	3529	--	uC

*Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycles $\leq 2\%$

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